Aug.1.2022 Copyright 2022 HIROSE ELECTRIC CO., LTD. All Rights Reserved.
In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-40°C TO + 85°C (NOTE 1) △1	STORAGE TEMPERATURE RANGE		-10°C TO + 60°C (NOTE 2)
	OPERATING HUMIDITY RANGE △1	40% TO 80% (NOTE 3)	STORAGE HUMIDITY RANGE △1		40% TO 70% (NOTE 2)
	VOLTAGE	AC 250V	UL・CSA RATING	VOLTAGE	AC 30V
	CURRENT	2A		CURRENT	2A

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100mA (DC OR 1000 Hz).	30mΩ MAX.	X	—
INSULATION RESISTANCE	500V DC.	1000MΩ MIN.	X	—
VOLTAGE PROOF	650V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	50TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
SHOCK	490 m/s^2 DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
ENVIRONMENTAL CHARACTERISTICS				
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35°C TIME 30→ 5MAX → 30→ 5MAX min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
RESISTANCE TO SOLDERING HEAT	1)AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE : 260±3°C FOR IMMERSION,DURATION , 10 sec . 2)MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 290±10°C SOLDERING TIME : 3 sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	–
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 10sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	–

	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△1	3	DIS-H-008583	MI. SAKIMURA	HK. UMEHARA	14.03.25

REMARKS
NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT
NOTE2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD,
OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.
NOTE3:NON-CONDENSING.
Unless otherwise specified , refer to IEC 60512.

APPROVED	KJ. KATAYOSE	05.01.05
CHECKED	TY. OMA	05.01.05
DESIGNED	IO. DENPOUYA	05.01.05
DRAWN	IO. DENPOUYA	05.01.05

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO. ELC4-162401-02

HRS	SPECIFICATION SHEET	PART NO.	DF11-*DS-2DSA(06)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL543 △1	1/1

FORM HD0011-2-1